

# 650V N-Channel MOSFET

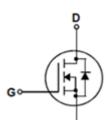
#### **General Description**

This Power MOSFET is produced using advanced planar stripe DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency switched mode power supplies, active power factor correction based on half bridge topology.

#### Features

7A, 650V, RDS(on)typ. = 1.65Ω@VGS = 10 V Advanced planar process Low gate charge minimize switching loss Fast switching 100% avalanche tested Improved dv/dt capability





Symbol	Parameter   Drain – Source Voltage			JFFC7N65E	Units
VDSS				650	V
lo	Drain Current	Continuous (	Tc = 25 °C )	7*	А
	Drain Current	Continuous (	Tc = 100 °C )	4*	А
DM	Drain Current - F	Pulsed	( Note 1 )	25	А
Vgss	Gate – Source Voltage			±30	V
EAS	Single Pulsed Avalanche Energy (Note 2)		( Note 2 )	106	mJ
Iar	Avalanche Current		( Note 1 )	7	А
Ear	Repetitive Avalanche Energy		( Note 1 )	10	mJ
dv/dt	Peak Diode Recove	ery dv/dt	( Note 3 )	5.0	V/ns
PD	Power Dissipation ( $T_c = 25 \degree C$ )			43	W
	-Derate above 25 °C			0.34	w/°C
TJ <b>,</b> Tstg	Operating and Storage Temperature Range			-55 to +150	°C
Τι	Maximum lead temperature for soldering purposes			300	°C
	1/8" frome case for 5 seconds			300	

#### Absolute Maximum Ratings Tc = 25 °C unless otherwise noted

\*Drain current limited by maximum junction temperature.



### **Thermal characteristics**

Symbol	Parameter	JFFC7N65E	Units
RθJC	Thermal Resistance, Junction-to-Case	2.9	°C/₩
Reja	Thermal Resistance, Junction-to-Ambient	62.5	°C/W

#### **Electrical Characteristics** Tc = 25 °C unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Charact	eristics	·		•	•	
BVDSS	Drain – Source Breakdown Voltage	V <sub>GS</sub> = 0 V, I <sub>D</sub> = 250 uA	650			V
⊿ BVdss/ ⊿TJ	Breakdown Voltage Temperature Coefficient	I <sub>D</sub> = 250 uA, Referenced to 25 °C		0.5		v/℃
IDSS		V <sub>DS</sub> = 650 V, V <sub>GS</sub> = 0 V			1	uA
	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 520 V, Tc = 125 ℃			10	uA
Igssf	Gate-Body Leakage Current, Forward	V <sub>GS</sub> = 30 V, V <sub>GS</sub> = 0 V			100	nA
GSSR	Gate-Body Leakage Current, Reverse	V <sub>GS</sub> = -30 V, V <sub>GS</sub> = 0 V			-100	nA
On Charact	eristics					
VGS(th)	Gate Threshold Voltage	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250 uA	2.0		4.0	V
RDS(on)	Static Drain-Source on-Resistance	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 3.5A		1.65	1.8	Ω
<b>g</b> FS	Forward Transconductance	V <sub>DS</sub> = 40 V, I <sub>D</sub> = 7 A (Note 4)		10		S
Dynamic Ch	naracteristics					
Ciss	Input Capacitance			680		pF
Coss	Output Capacitance	$V_{DS} = 25 V, V_{GS} = 0 V, f = 1.0 MU_{T}$		70		pF
Crss	Reverse Transfer Capacitance			8.4		рF
Switching C	haracteristics					
td(on)	Turn-On Delay Time			12		ns
tr	Turn-On Rise Time	V <sub>DS</sub> = 325 V, I <sub>D</sub> = 7.0 A , R <sub>G</sub> =		15		ns
td(off)	Turn-Off Delay Time	$25\Omega$ , V <sub>GS</sub> = 10 V (Note 4,5)		32		ns
tr	Turn-Off Fall Time			16		ns
Qg	Total Gate Charge			17		nC
Qgs	Gate-Source Charge	VDS = 480 V, ID = 7.0 A VGS = 10 V (Note 4,5)		4		nC
$\mathbf{Q}_{gd}$	Gate-Drain Charge	10 V (Note 4,5)		7		nC
Drain – Sou	rce Diode Characteristics and Maximum Ra	tings				
ls	Maximum Continuous Drain-Source Diode	Forward Current			7	Α
lsм	Maximum Pulsed Drain-Source Diode Forward Current				25	А
Vsd	Drain-Source Diode Forward Voltage	V <sub>GS</sub> = 0 V, I <sub>S</sub> = 7.0 A			1.2	V
trr	Reverse Recovery Time	V <sub>GS</sub> = 0 V, I <sub>S</sub> = 7.0 A		300		ns
Qrr	Reverse Recovery Charge	dlr/dt = 100 A/us (Note 4)		3.1		uC

#### Notes:

1. Repetitive Rating : Pulsed width limited by maximum junction temperature

2. L = 4.0mH , Ias = 7A, V\_{DD} = 50V, R\_G = 25\Omega, Starting T\_J = 25  $^\circ \! C$ 

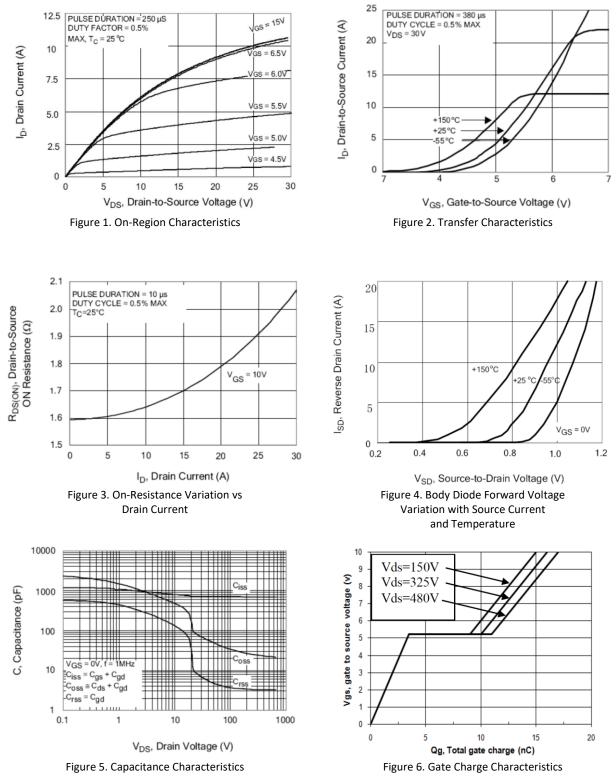
3.  $I_{SD} \leq 7.0A$ ,  $di/dt \leq 200A/us$ ,  $V_{DD} \leq BV_{DSS}$ ,  $Starting T_J = 25^{\circ}C$ 

4. Pulsed Test : Pulsed width  $\leq$ 300us, Duty cycle  $\leq$  2%

5. Essentially independent of operating temperature

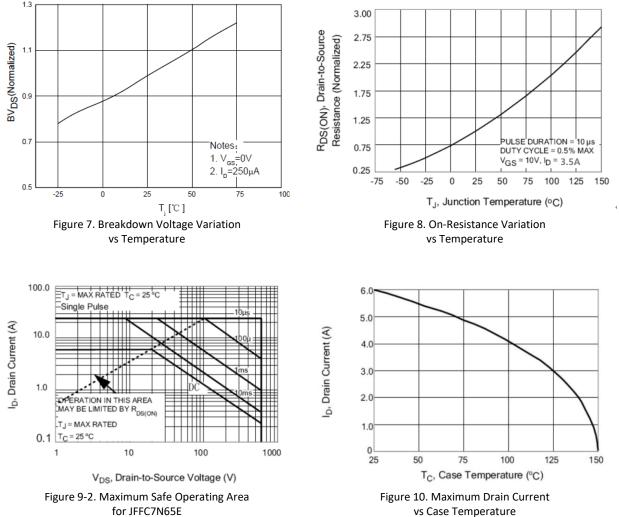


# **Typical Characteristics**



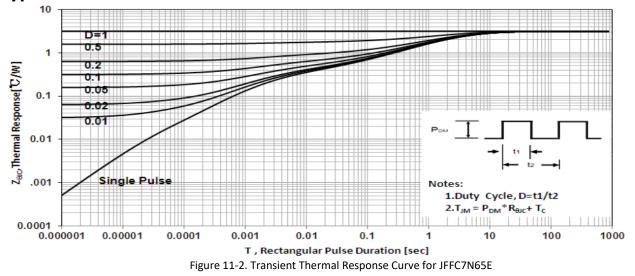


### **Typical Characteristics**



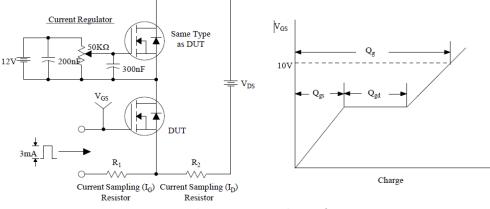


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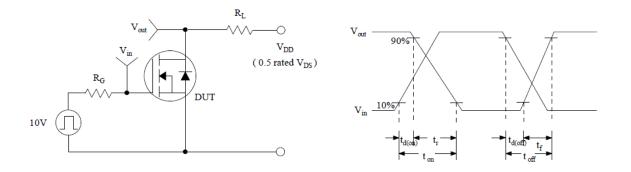




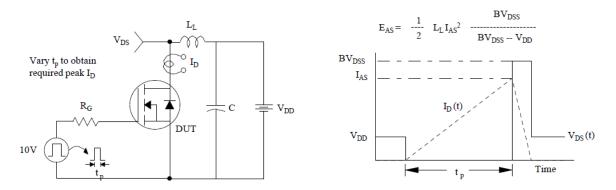
### Test Circuit & Waveform







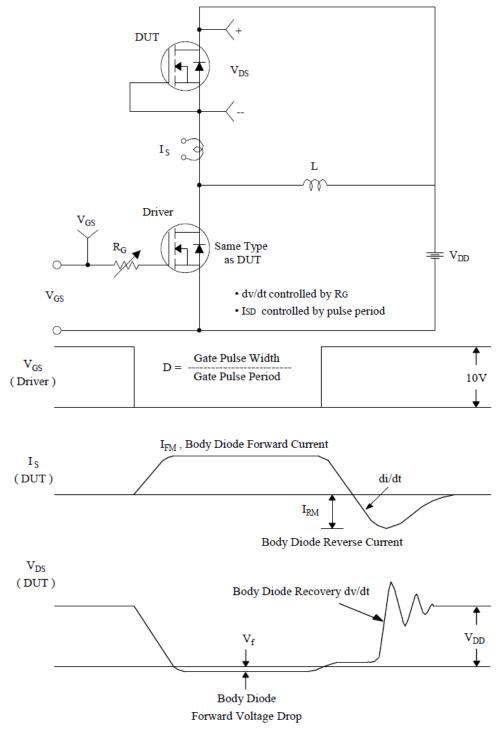
Resistive Switching Test Circuit & Waveforms



Unclamped Inductive Switching Test Circuit & Waveforms

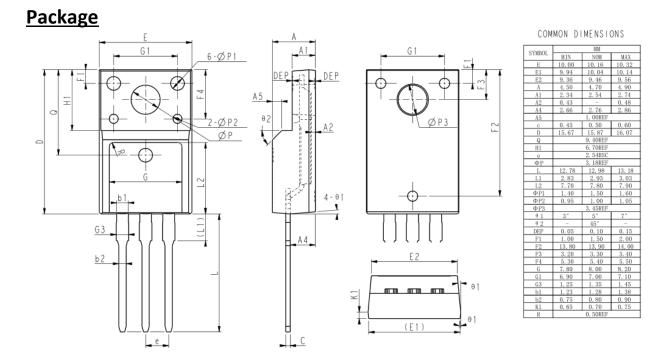


#### **Test Circuit & Waveform**



Peak Diode Recovery dv/dt Test Circuit & Waveforms







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